

H08T60

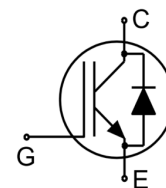
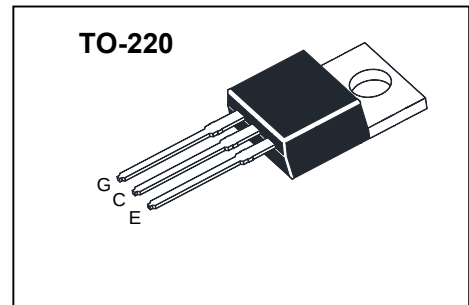
Insulated Gate Bipolar Transistor

Features

- Very low $V_{CE(sat)}$
- High speed switching
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Applications

- Air Condition
- Inverters
- Motor drives



Schematic diagram

Absolute Maximum Ratings ($T_j = 25^\circ\text{C}$ unless otherwise specified):

Symbol	Parameter	Rating	Units
V_{CES}	Collector-Emitter Voltage	600	V
V_{GES}	Gate- Emitter Voltage	± 20	V
I_C	Collector Current@ $T_C=25^\circ\text{C}$	16	A
	Collector Current @ $T_C = 100^\circ\text{C}$	8	
I_{CM}^{a1}	Pulsed Collector Current	32	A
I_F	Diode Continuous Forward Current @ $T_C = 25^\circ\text{C}$	20	A
	Diode Continuous Forward Current @ $T_C = 100^\circ\text{C}$	10	A
I_{FM}	Diode Maximum Forward Current	30	A
P_D	Power Dissipation @ $T_C = 25^\circ\text{C}$	104	W
T_J	Operating Junction	$-55 \sim 150$	$^\circ\text{C}$
T_{stg}	Storage Temperature Range	$-55 \sim 150$	$^\circ\text{C}$
T_L	Maximum Temperature for Soldering	260	$^\circ\text{C}$

^{a1}: Repetitive rating; pulse width limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Thermal Resistance, Junction to case for IGBT	--	1.19	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance, Junction to case for Diode	--	1.23	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	--	43.18	$^\circ\text{C/W}$

Electrical Characteristics of the IGBT ($T_j = 25^\circ\text{C}$ unless otherwise specified):

Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Un its
OFF Characteristics						
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	V _{GE} =0V,I _{CE} =250uA	600	--	--	V
I _{CES}	Collector-Emitter Leakage Current	V _{GE} =0V,V _{CE} =600V	--	--	150	μA
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} =+20V	--	--	+100	nA
I _{GES(R)}	Gate to Source Reverse Leakage	V _{GE} =-20V	--	--	-100	nA
ON Characteristics						
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C =8A ,V _{GE} =15V	--	1.6	2.2	V
V _{GE(th)}	Gate Threshold Voltage	I _C =250u A ,V _{CE} =V _{GE}	4.4	5.4	6.2	V
Pulse width tp≤300μs,δ≤2%						
Dynamic Characteristics						
C _{ies}	Input Capacitance	V _{CE} =25V,V _{GE} =0V f=1MHz	--	611	--	pF
C _{oes}	Output Capacitance		--	40	--	
C _{res}	Reverse Transfer Capacitance		--	9	--	
Switching Characteristics						
t _{d(on)}	Turn-on Delay Time	V _{CE} =400V,I _C =8A, R _g =10 Ω ,V _{GE} =15V, Inductive Load, T _j =25℃ ,	--	7	--	ns
t _r	Rise Time		--	23	--	
t _{d(off)}	Turn-Off Delay Time		--	48	--	
t _f	Fall Time		--	79	--	
E _{on}	Turn-On Switching Loss		--	0.15	--	mJ
E _{off}	Turn-Off Switching Loss		--	0.17	--	
E _{ts}	Total Switching Loss		--	0.32	--	
Q _g	Total Gate Charge	V _{CE} =480V,I _C =8A, V _{GE} =15V,	--	44	--	nC
Electrical Characteristics of the DIODE (T _j = 25℃ unless otherwise specified):						
V _F	Diode Forward Voltage	I _F =8A	--	2.0	2.6	V
t _{rr}	Reverse Recovery Time	I _F =10A di/dt=100A/uS	--	47	--	ns
I _{rrm}	Reverse Recovery Current		--	7.5	--	A
Q _{rr}	Reverse Recovery Charge		--	176	--	nC

Typical Performance Characteristics

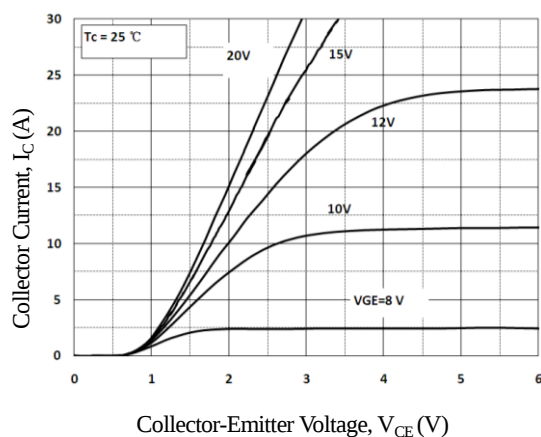


Figure 1. Output Characteristics

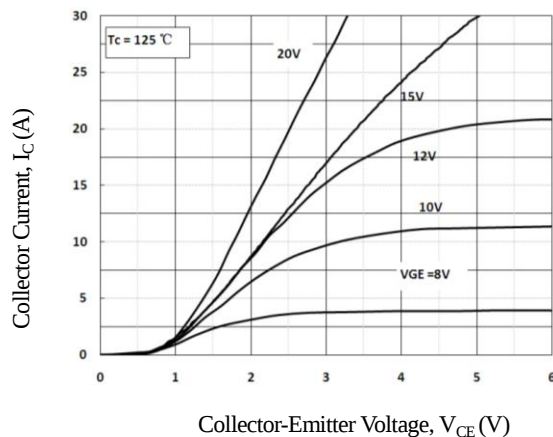


Figure 2. Output Characteristics

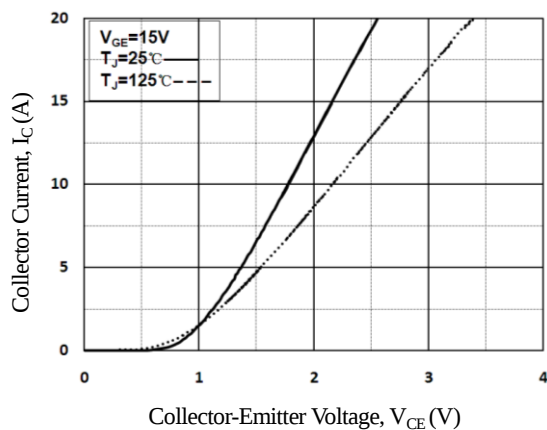


Figure 3. Saturation Voltage Characteristics

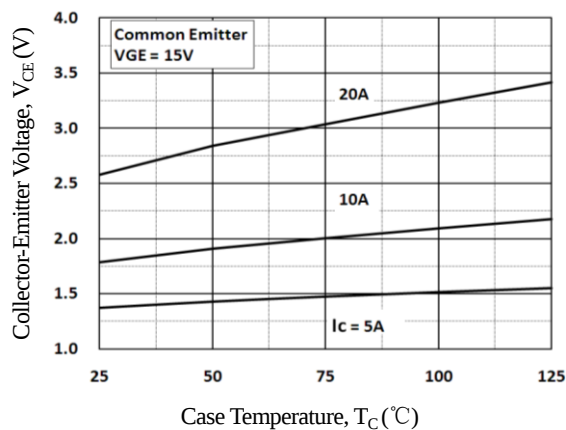


Figure 4. Saturation Voltage - T_c Characteristics

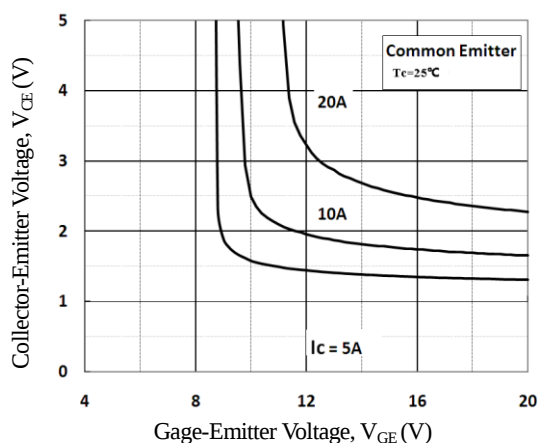


Figure 5. $V_{CE(sat)}$ - V_{GE} Characteristics

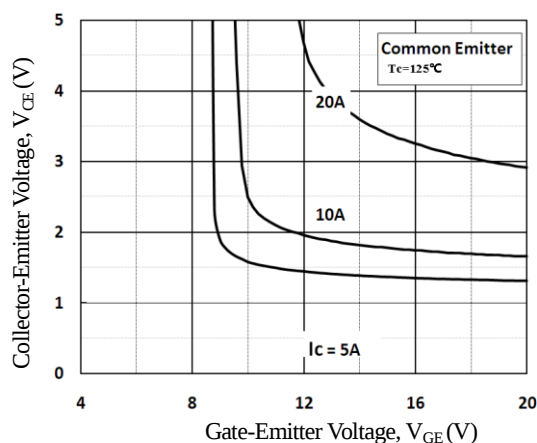


Figure 6. $V_{CE(sat)}$ - V_{GE} Characteristics

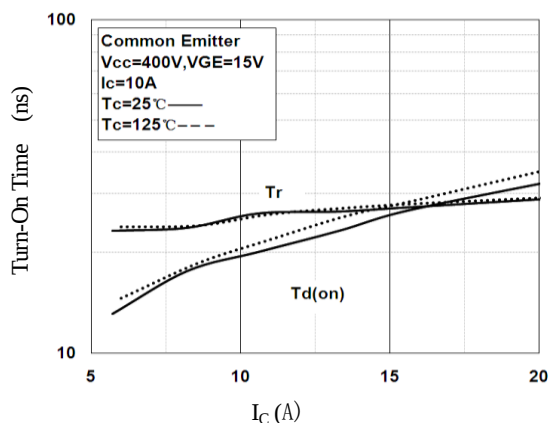


Figure 7. Turn-On Time-Ic Characteristics

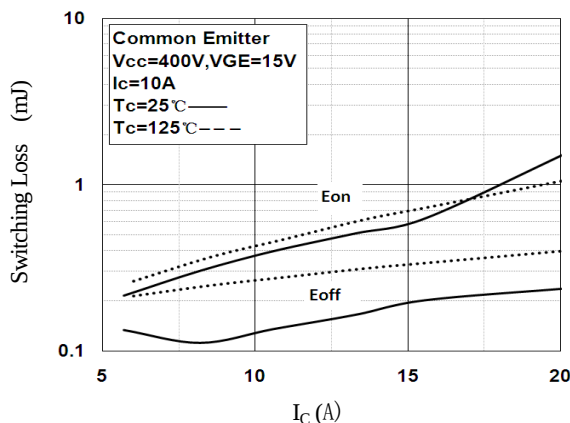


Figure 8. Switching Loss-Ic Characteristics

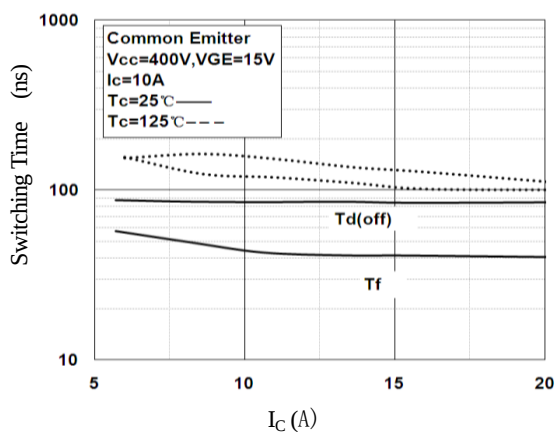


Figure 9. Turn-Off Time-Ic Characteristics

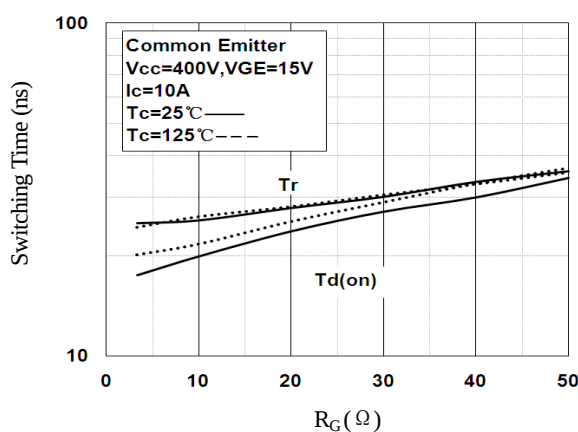


Figure 10. Switching Time- R_G Characteristics

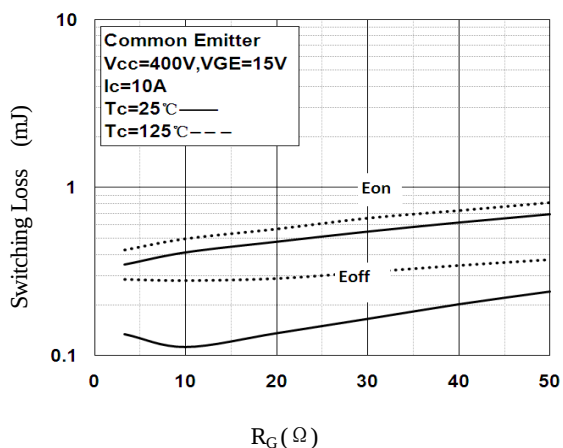


Figure 11. Switching Loss- R_G Characteristics

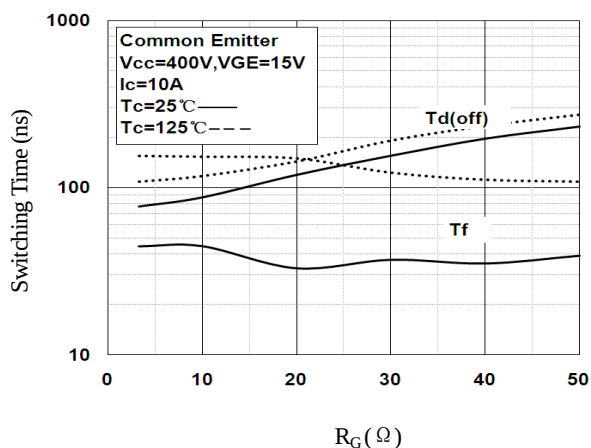


Figure 12. Switching Time- R_G Characteristics

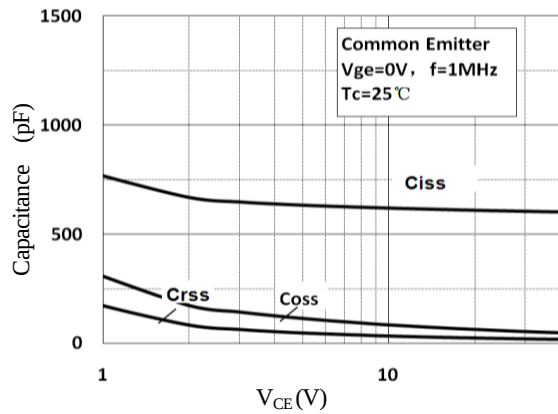


Figure 13. Capacitance Characteristics

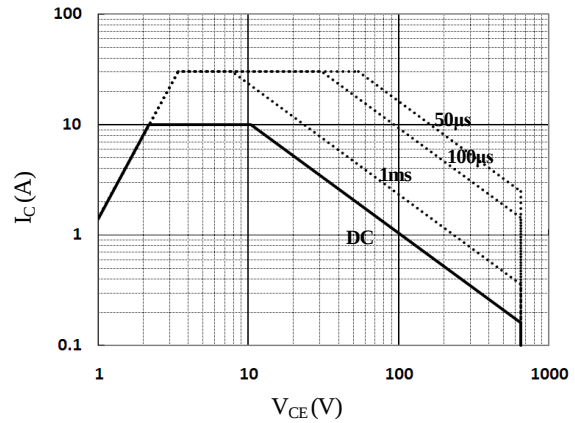


Figure 14. Forward Bias Safe Operating Area

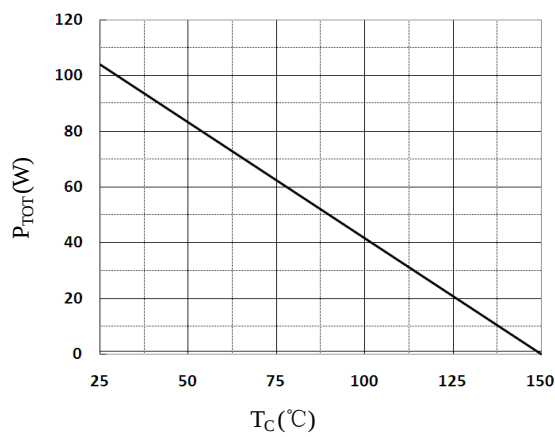


Figure 15. Power Dissipation- T_C Characteristics

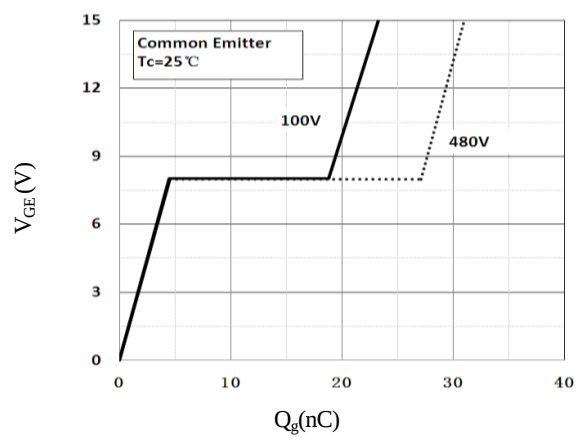


Figure 16. Gage Charge Characteristics

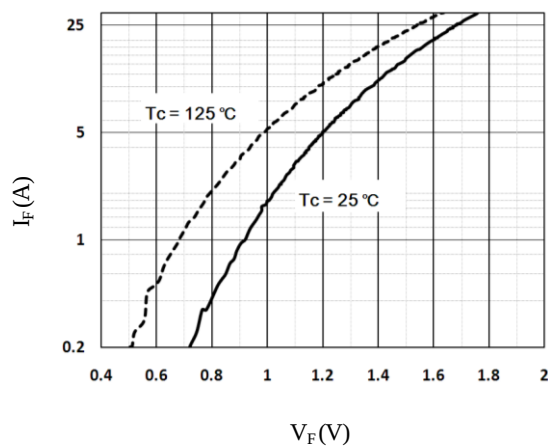


Figure 17. Diode Forward Characteristics

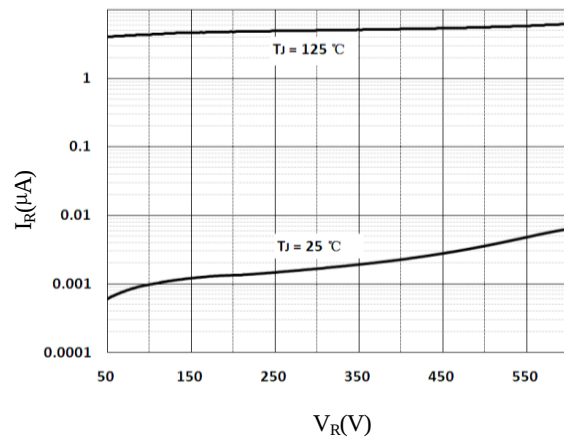
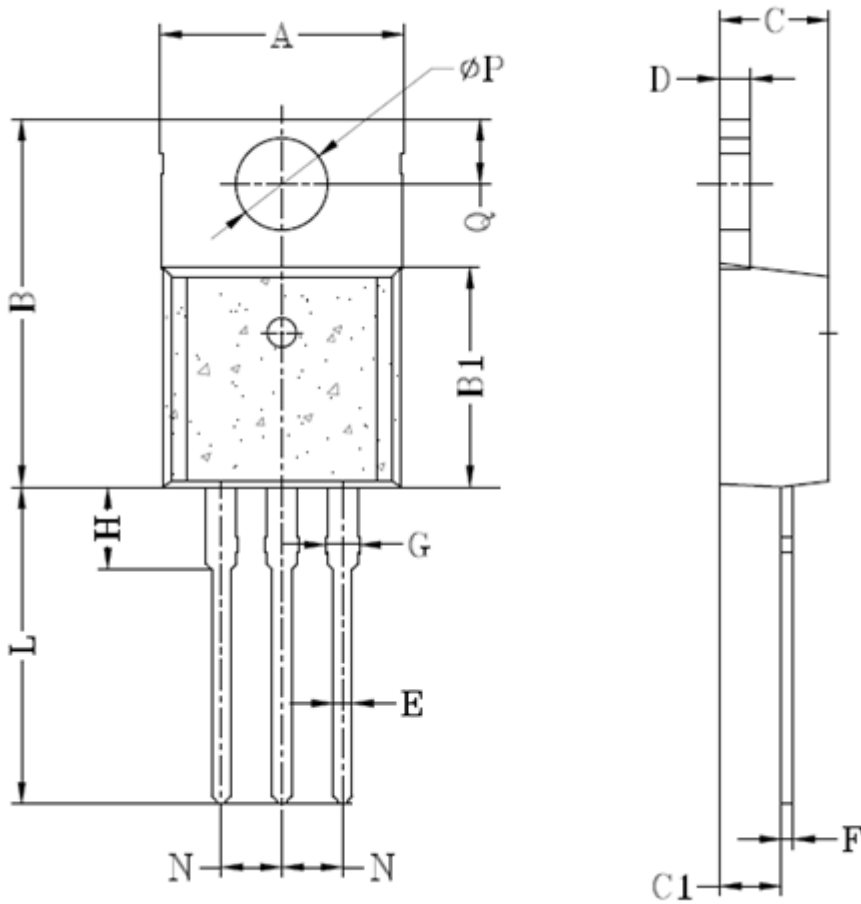


Figure 18. Diode Reverse Characteristics

Package Information



Symbol	unit(mm)	
	MIN	MAX
A	10.0	10.4
B	15.2	15.6
B1	9.00	9.60
C	4.47	4.67
C1	2.28	2.88
D	1.20	1.40
E	0.70	0.90
F	0.40	0.60
G	1.27	1.47
H	3.20	3.70
L	12.95	13.55
N	2.34	2.74
Q	2.44	3.04
Ø P	3.74	3.94

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